

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TATSUYA ASAHATA	05/16/2016
RECEIVING PARTY DATA	
Name:	HITACHI HIGH-TECH SCIENCE CORPORATION
Street Address:	24-14, NISHI-SHIMBASHI 1-CHOME
City:	MINATO-KU, TOKYO
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15181702
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DATE SIGNED:	06/14/2016
Total Attachments: 3	
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ASSIGNMENT

WHEREAS, we,

ASAHATA, Tatsuya,

MORI, Akito,

YUZURIHA, Asumi,

each residing at

c/o HITACHI HIGH-TECH SCIENCE CORPORATION, 24-14, Nishi-shimbashi 1-chome,
Minato-ku, Tokyo, Japan,

c/o Aoi Electronics Co., Ltd., 455-1, Kohzai Minamimachi, Takamatsu, Kagawa,
Japan,

c/o Aoi Electronics Co., Ltd., 455-1, Kohzai Minamimachi, Takamatsu, Kagawa,
Japan,

have invented new and useful improvements in

MICROSAMPLE STAGE AND METHOD OF MANUFACTURING THE SAME

for which we have prepared an application for Letters Patent of the United States of America;

AND WHEREAS, **HITACHI HIGH-TECH SCIENCE CORPORATION**, a Japanese corporation located and doing business 24-14, Nishi-shimbashi 1-chome, Minato-ku, Tokyo, Japan, is desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor;

NOW, THEREFORE, be it known by all whom it may concern, that for and in consideration of Ten Dollars (\$10.00) and other good and valuable consideration to us in hand paid, the receipt of which is hereby acknowledged, we have assigned, sold and transferred and by these presents do hereby assign, sell and transfer unto the said **HITACHI HIGH-TECH SCIENCE CORPORATION**

for the territory of the United States of America, our entire right, title and interest in and to the said invention, and in and to the said application, prepared and executed by us on _____

May 16, 2016; May 16, 2016; and May 16, 2016,
respectively, filed June 14, 2016, Appln. No. 15/181,702,
preparatory to obtaining Letters Patent thereon and in and to any and
all divisions, reissues and continuations thereof, and in and to any
Letters Patent that may be granted thereon; said invention, application
and Letters Patent to be held and enjoyed by the said HITACHI HIGH-TECH
SCIENCE CORPORATION, its legal representatives and assigns, as fully and
entirely as the same would have been held by us had this assignment, sale
and transfer not been made.

AND, we hereby covenant and agree that we will at any time upon
the request and at the expense of said assignee execute and deliver any
and all papers and do all lawful acts that may be necessary or desirable
to perfect the title to said invention and to obtain Letters Patent therefor,
and we hereby authorize and request the Honorable Commissioner of Patents
and Trademarks to issue the said Letters Patent to the said HITACHI HIGH-TECH
SCIENCE CORPORATION in accordance with this assignment.

Executed this 16th day of May 2016.

Witness:

Tatsuya Asahata (L.S.)
ASAHATA, Tatsuya

_____ (L.S.)
MORI, Akito

_____ (L.S.)
YUZURIHA, Asumi